DZ2W047

Silicon epitaxial planar type

For constant voltage / waveform clipper and surge absorption circuit Capability of withstanding a high surge type

■ Features

- Excellent rising characteristics of zener current I_Z
- Low zener operating resistance R_Z
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Repetitive peak forward current	I _{FRM} 500		mA	
Total power dissipation *1	P _T	1	W	
Junction temperature	T_j	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	
Non-repetitive reverse surge power dissipation *2	P _{ZSM}	100	W	

Note) *1: Mounted on ceramics print circuit board.

Board size: 50 mm \times 50 mm, Board thickness: 0.8 mm, Soldering size: 2 mm \times 2 mm

■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_F = 200 \text{ mA}$			1.2	V
Zener voltage *1,2	Vz	$I_Z = 20 \text{ mA}$	4.47	4.70	4.94	V
Zener operating resistance	R_Z	$I_Z = 20 \text{ mA}$			60	Ω
Reverse current	I_R	$V_R = 1 V$			40	μΑ
Temperature coefficient of zener voltage *3	S _Z	$I_Z = 20 \text{ mA}$		-0.8		mV/°C

 $Note) \ 1. \ Measuring \ methods \ are \ based \ on \ JAPANESE \ INDUSTRIAL \ STANDARD \ JIS \ C \ 7031 \ measuring \ methods \ for \ diodes.$

■ Package

Code

Mini2-F3-B

- Pin Name
 - 1. Cathode
 - 2. Anode
- Marking Symbol: AJ

^{*2:} t = 0.1 ms

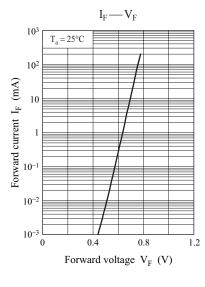
^{2.} Absolute frequency of input and output is 5 MHz.

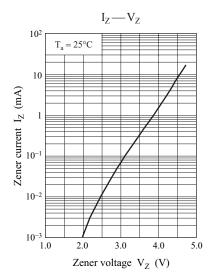
^{3. *1:} The temperature must be controlled 25°C for V_Z measurement. V_Z value measured at other temperature must be adjusted to V_Z (25°C)

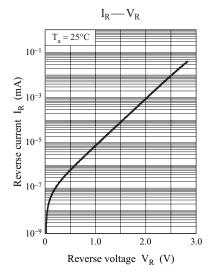
^{*2:} Vz guaranteed 20 ms after current flow.

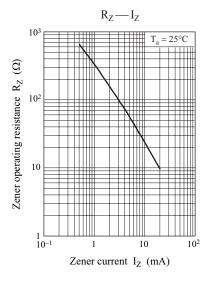
^{*3:} $T_i = 25^{\circ}C$ to $150^{\circ}C$

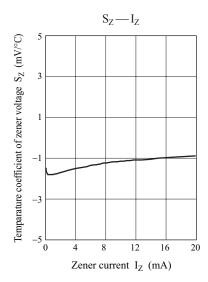
DZ2W047 Panasonic

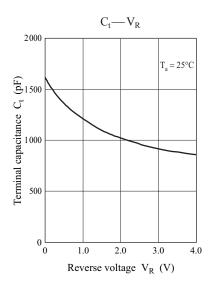








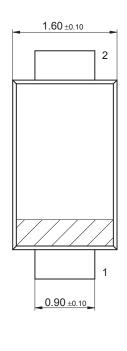


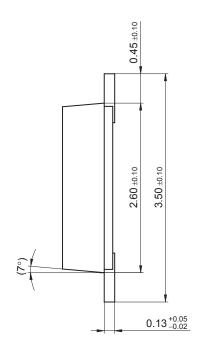


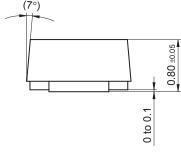
2 Ver. BED

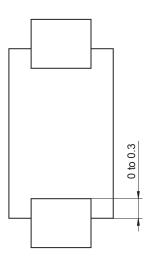
Mini2-F3-B

Unit: mm









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